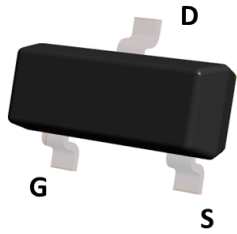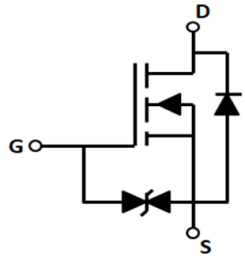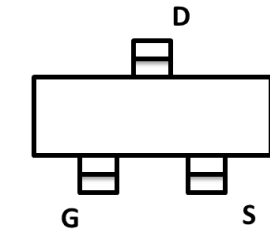# N-Channel Enhancement Mode Field Effect Transistor

Top View

SOT-23

Product Summary

- V_{DS} 30V
- I_D 560mA
- $R_{DS(ON)}$(at V_{GS}=4.5V)   ＜1.5ohm
- $R_{DS(ON)}$(at V_{GS}=3.7V)   ＜2.5ohm

General Description

- Trench Power MV MOSFET technology
- Voltage controlled small signal switch
- Low input Capacitance
- Fast Switching Speed
- Low Input / Output Leakage

Applications

- Battery operated systems
- Solid-state relays
- Direct logic-level interface：TTL/CMOS

■ Absolute Maximum Ratings (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	V_{DS}	30	V
Gate-source Voltage	V_{GS}	±20	V
Drain Current	I_D	560	mA
Pulsed Drain Current [A]	I_{DM}	1.7	A
Total Power Dissipation @ T_A=25℃	P_D	690	mW
Thermal Resistance Junction-to-Ambient @ Steady State [B]	$R_{\theta JA}$	357	℃/ W
Junction and Storage Temperature Range	T_J ,T_{STG}	-55～+150	℃

■ Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter			2			
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}= 0V, I_D=250μA	30			V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=30V,V_{GS}=0V			1	μA
Gate-Body Leakage Current	I_{GSS1}	V_{GS}= ±20V, V_{DS}=0V			±1	μA
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}= V_{GS}, I_D=250μA	0.8		1.6	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	V_{GS}= 4.5V, I_D=10mA		1.2	1.5	Ω
		V_{GS}= 3.7V, I_D=10mA		1.9	2.5	
Diode Forward Voltage	V_{SD}	I_S=300mA,V_{GS}=0V			1.2	V
Maximum Body-Diode Continuous Current	I_S				100	mA
Dynamic Parameters						
Input Capacitance	C_{iss}			17.5		pF
Output Capacitance	C_{oss}	V_{DS}=25V,V_{GS}=0V,f=1MHZ		11.5		
Reverse Transfer Capacitance	C_{rss}			6.5		
Switching Parameters						
Total Gate Charge	Q_g	V_{GS}=10V,V_{DS}=25V,I_D=0.3A		1.7	2.4	nC
Turn-on Delay Time	$t_{D(on)}$	V_{GS}=10V,V_{DD}=25V, I_D=100mA, R_{GEN}=6Ω		5		ns
Turn-off Delay Time	$t_{D(off)}$			17		
Reverse recovery Time	t_{rr}	V_{GS}=0V,I_S=300mA,V_R=25V, dI_S/dt=-100A/μs		30		ns

A. Pulse Test: Pulse Width≤300us,Duty cycle ≤2%.
B. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

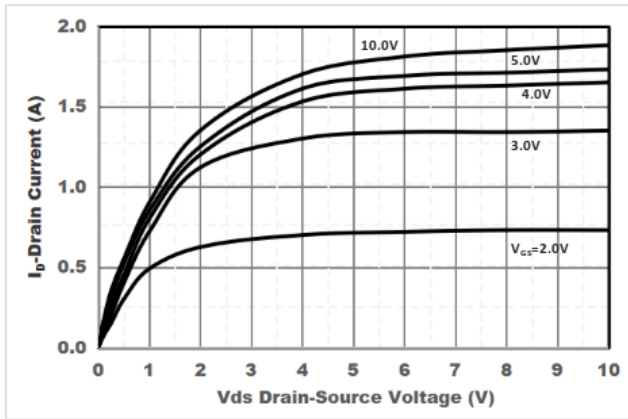## ■ Typical Performance Characteristics

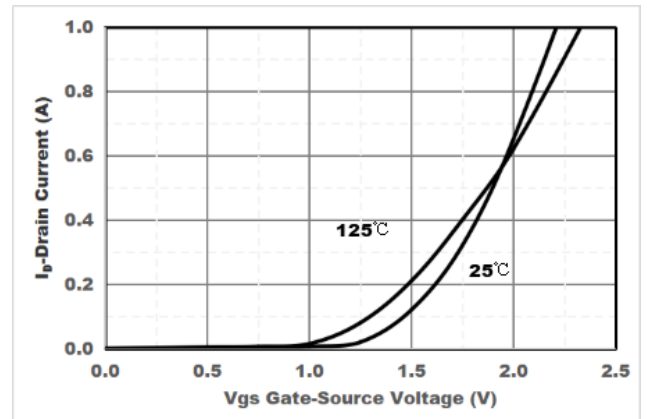Figure1. Output Characteristics

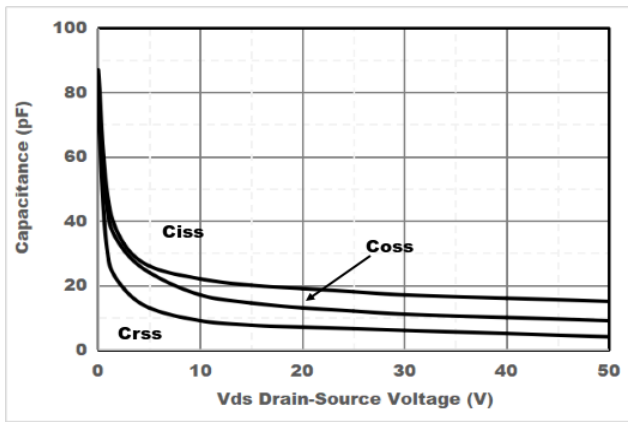
Figure2. Transfer Characteristics
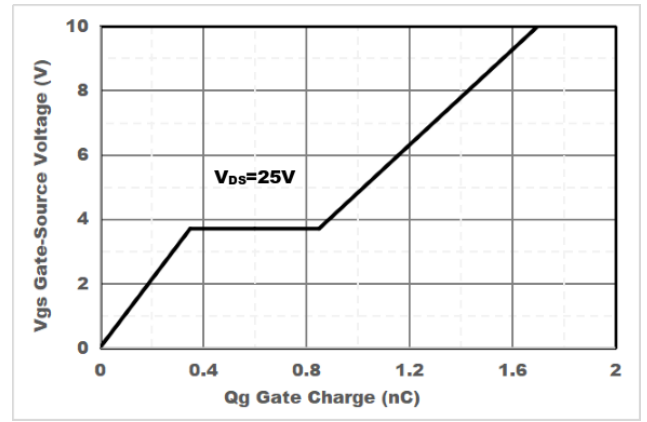

Figure3. Capacitance Characteristics
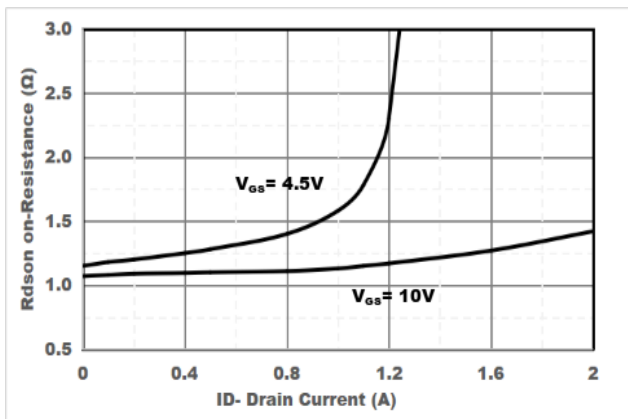

Figure4. Gate Charge
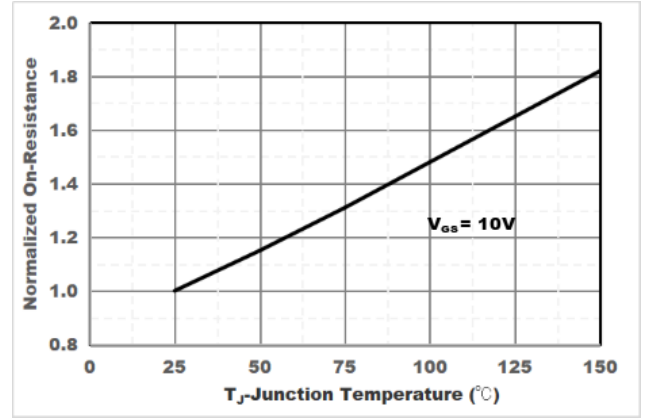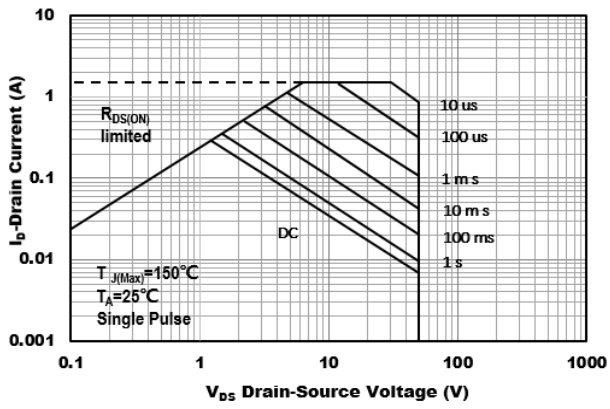

Figure5. Drain-Source on Resistance

Figure6. Drain-Source on Resistance
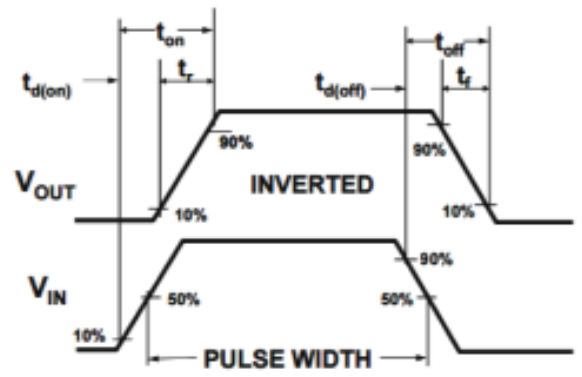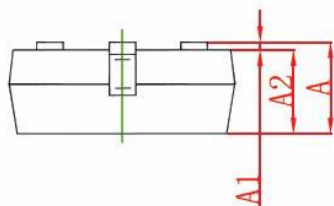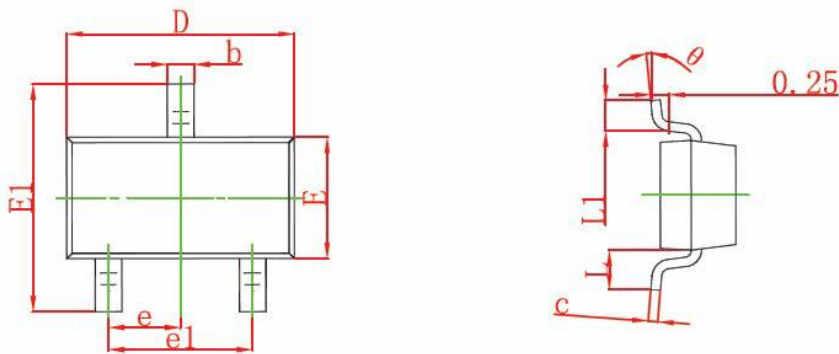
Figure7. Safe Operation Area

Figure8. Switching wave

■ SOT-23 Package information

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

■ SOT-23 Suggested Pad Layout

Note:
1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05mm.
3. The pad layout is for reference purposes only.

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